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PATENT ?

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Corisis et al.

Serial No.: 09/416,368

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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Washington, D.C. 20231

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO/SB/08 be considered by the Examiner and made of record. The listed documents were cited by the office in co-pending application Serial No. 09/944,472, filed on August 30, 2001, and directed to a related invention. Copies of the listed documents are enclosed pursuant to 37 C.F.R. § 1.98(a).

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as

defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.



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Serial No.: 09/416,368

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NASIATKA et al., "Determination of Optimal Solder Volume for Precision Self-Alignment of BGA using Flip-Chip Bonding," pps. 6-9.

Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed after the mailing date of the first Office Action on the merits.

The fee pursuant to 37 C.F.R. § 1.17(p) is enclosed.

Respectfully submitted,

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BBJ/hlg:djp

Enclosures: Form PTO-PTO/SB/08

Copy of documents cited

Document in ProLaw